"PRO INVENT" RESEARCH CONFERENCE-24.03.2016

Advanced spintronic devices for communication and data storage technologies based on Heusler compounds <SPINCOD>

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Spintronics





Purpose of spin-electronics: ``Teaching electrons new tricks´´ by manipulating the electron spin in solid state electronic devices

combine electronics and magnetism in order to make new devices in which both the charge and the spin of the electron play an active role

Spin dependent transport

Spintronic devices are based on the spin dependent electronic transport

Electronic structure of a 3d ferromagnetic material



Fermi Golden rule:

$$P_{s-d}^{\sigma} \propto |M_{s-d}|^2 d_{\sigma}(E_F)$$

Different s-d scattering rates for spin up and down electrons



Current carried in two independent "spin-up" and "spin-down" channels

Ferromagnetic film – spin filter



$$\begin{aligned} \lambda_{\uparrow Co} = 10nm; \lambda_{\downarrow Co} = 1nm\\ \rho^{\uparrow} << \rho^{\downarrow} \end{aligned}$$

Magnetic tunnel junction (MTJ)

Two ferromagnetic electrodes separated by an insulating tunnel barrier
Co.FeAl









Mg(

2nm

$$\frac{\Delta R}{R} = \frac{R_{AP} - R_P}{R_P} = \frac{2P_P P_A}{1 - P_P P_A}$$

TMR amplitude ~ P amplitude

Magnetic tunnel junction (MTJ) - read head in HDD



Magnetic tunnel junction (MTJ)— elementary cell of magnetic random access memories (MRAM)



S.Tehrani et al. PROCEEDINGS OF THE IEEE, VOL. 91, NO. 5

Next generation of magnetic tunnel junctions – Material challenges

Performance of MTJs dependent on the TMR amplitude, the switching speed and mag-noise ratio:

Increased TMR -> MTJ with electrodes having P=100% - half metal

Increased switching speed -> MTJ with electrodes having low damping

Optimize mag-noise -> optimally controlled high frequency damping

Elaboration and characterization of highly spin polarized Heusler alloys thin films with extrinsically controlled Gilbert damping and their integration in spintronic devices.

O1: Deposition and characterization of highly spin polarized Heusler alloys thin films as electrodes for MTJs

O2: Deposition and characterization of Heusler based MTJs with extrinsically controlled high frequency damping

Why Heusler ???

SPINCOD – RESULTS - Half metallic Co₂FeAl_xSi_{1-x} Heusler alloys

 $L2_1$

• X

YZ

• Co₂FeAl_xSi_{1-x} full Heusler

- \succ alloys L2₁ structure belonging to the 225 (Fm-3m) space group:
- high Curie temperature > 700 K
- > localized magnetic character (4.96 $\mu_{\rm B}$ /f.u.)
- spin resolved band structure calculations
 Wien 2k *ab-initio* code LSDA+U formalism



SPINCOD – RESULTS - Half metallic CFAS Heusler alloys thin films

• MgO(001)//Co₂FeAl_{0.5}Si_{0.5} (25 nm)/ MgO(5 nm)





Epitaxial growth confirmed by TEM



$$\Delta \rho_{xx}(T,H) = 1 - \frac{\rho_{xx}(T,H) - \rho_{xx}(T,0)}{\rho_{xx}(4\ K,H) - \rho_{xx}(4\ K,0)}$$



• Half metallic character (100 % SP)

SPINCOD – RESULTS – High frequency dynamics

High frequency dynamics



LLG equation:





RT

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$$\Delta H^{PP} = \frac{2}{\sqrt{3}} \frac{2\pi}{\gamma} \times \alpha_{\rm eff} f + \Delta H_0$$

Linewidth vs. frequency gives the effective damping constant:

• CFAS films:

 $\alpha = 1.9 \times 10^{-3}$ (for Permalloy : $\alpha \approx 10^{-2}$).

(a)

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SPINCOD – RESULTS – Controlling damping through spin pumping

High frequency dynamics



LLG equation:





Si/SiO2/CFAS (10 nm)/ Cu_{0.94}Ir_{0.06}(t nm)/Al(1.3 nm)



CFAS ideal electrode for MTJs

Research strategy - SPINCOD

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	Commercial applications
=	Spintronic devices
	Advanced materials







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